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OCT 26 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)	
Chen, et al.)	Confirmation No.: 9818
Serial No.: 10/810,965)	Examiner: Trinh, Hoa B.
Filed: March 26, 2004)	Group Art Unit: 2814
For: Novel Method to Improve Bump Reliability for)	TKHR Docket: 252016-2530
Flip Chip Device)	Top-Team: 0503-A30731US

CERTIFICATE OF FACSIMILE TRANSMISSION UNDER 37 CFR §1.8

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October 26, 2005
Date

Hui Chin Barnhill
Hui Chin Barnhill

AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION WITH RCE

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

The FINAL Office Action mailed August 23, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.